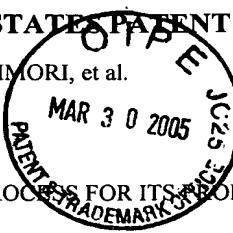


*Due 1/8
cc*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yoshihiro FUJIMORI, et al.
SERIAL NO: 10/650,790
FILED: August 29, 2003
FOR: POLYESTER RESIN AND PROCESS FOR ITS PRODUCTION



GAU: 1711

EXAMINER: Acquah, S.A.

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references cited on the attached Supplementary European Search Report and listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

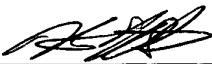
- Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.
Norman F. Oblon

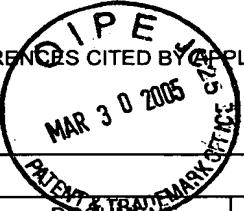


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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 242136US0DIV		SERIAL NO. 10/650,790	
LIST OF REFERENCES CITED BY APPLICANT 		APPLICANT		Yoshihiro FUJIMORI, et al.			
		FILING DATE		GROUP			
		August 29, 2003		1711			
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
AA		6,013,756	01/11/00	Hagen et al.			
AB		5,688,899	11/18/97	Strand et al.			
AC		3,907,754	09/23/75	Tershansy et al.			
AD		6,066,714	05/23/00	Putzig et al.			
AE							
AF							
AG							
AH							
AI							
AJ							
AK							
AL							
AM							
AN							
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION		
	AO	0 284 426 A2	09/28/88	Europe	YES		NO
	AP	11-199660	07/27/99	Japan w/attached English Abstract			
	AQ	4-255753	09/10/92	Japan w/attached English Abstract			
	AR	2001-2792	01/09/01	Japan w/attached English Abstract			
	AS	9-76336	03/25/97	Japan w/attached English Abstract			
	AT	9-221540	08/26/97	Japan w/attached English Abstract			
	AU	EP 0 892 000 A1	01/20/99	Europe			
	AV	EP 1 281 725 A1	02/05/03	Europe			
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
	AW						
	AX						
	AY						
	AZ					<input type="checkbox"/> Additional References sheet(s) attached	
Examiner					Date Considered		

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.